



# PBSS4480X-Q

80 V, 4 A NPN low V<sub>CEsat</sub> transistor

5 June 2024

Product data sheet

## 1. General description

NPN low V<sub>CEsat</sub> transistor in a SOT89 (SC-62) medium power and flat lead plastic package.

PNP complement: PBSS5480X

## 2. Features and benefits

- High h<sub>FE</sub> and low V<sub>CEsat</sub> at high current operation
- High collector current capability: I<sub>C</sub> maximum 4 A
- High efficiency leading to less heat generation
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Medium power peripheral drivers; e.g. fan, motor
- Strobe flash units for DSC and mobile phones
- Inverter applications; e.g. TFT displays
- Power switch for LAN and ADSL systems
- Medium power DC-to-DC conversion
- Battery chargers

## 4. Quick reference data

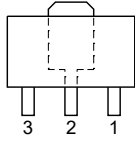
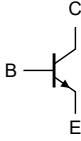
Table 1. Quick reference data

| Symbol             | Parameter                               | Conditions   | Min | Typ | Max | Unit |
|--------------------|---|--|-----|-----|-----|------|
| V <sub>CEO</sub>   | collector-emitter voltage               | open base  | -   | -   | 80  | V    |
| I <sub>C</sub>     | collector current                       | [1]  | -   | -   | 4   | A    |
| I <sub>CM</sub>    | peak collector current                  | limited by T <sub>j(max)</sub> ; single pulse; t <sub>p</sub> ≤ 1 ms   | -   | -   | 10  | A    |
| R <sub>CEsat</sub> | collector-emitter saturation resistance | I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C | -   | 40  | 54  | mΩ   |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline  | Graphic symbol   |
|-----|--------|-------------|---|--|
| 1   | E      | emitter     |  <p style="text-align: center;"><b>SOT89</b></p> |  <p style="text-align: center;"><i>sym123</i></p> |
| 2   | C      | collector   |   |  |
| 3   | B      | base        |   |  |

## 6. Ordering information

Table 3. Ordering information

| Type number                 | Package |  |                       |
|-----------------------------|---------|--|-----------------------|
|                             | Name    | Description  | Version               |
| <a href="#">PBSS4480X-Q</a> | SOT89   | plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body | <a href="#">SOT89</a> |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code <sup>[1]</sup> |
|-------------|-----------------------------|
| PBSS4480X-Q | %1Y                         |

[1] % = placeholder for manufacturing site code

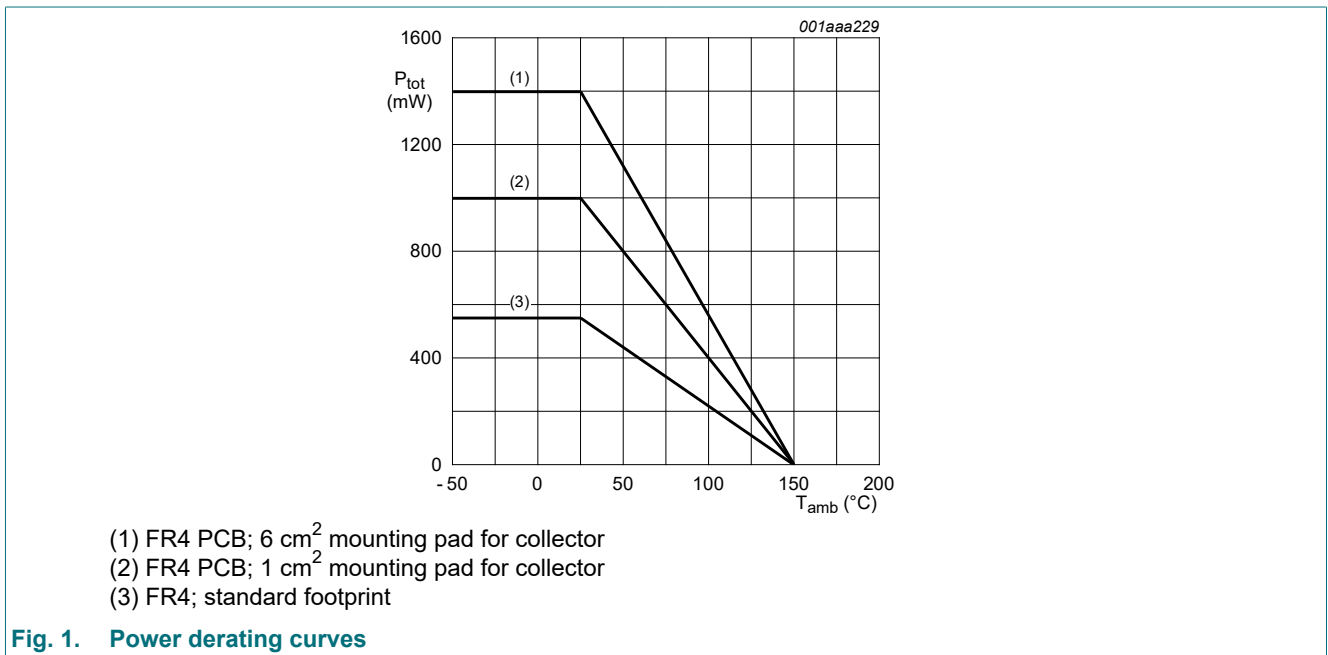
## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                         | Conditions   |         | Min | Max | Unit |
|------------------|-----------------------------------|--|---------|-----|-----|------|
| V <sub>CBO</sub> | collector-base voltage            | open emitter   |         | -   | 80  | V    |
| V <sub>CEO</sub> | collector-emitter voltage         | open base  |         | -   | 80  | V    |
| V <sub>EBO</sub> | emitter-base voltage              | open collector   |         | -   | 5   | V    |
| I <sub>C</sub>   | collector current                 |  | [1]     | -   | 4   | A    |
| I <sub>CRM</sub> | repetitive peak collector current | t <sub>p</sub> ≤ 10 ms   |         | -   | 6   | A    |
| I <sub>CM</sub>  | peak collector current            | limited by T <sub>j(max)</sub> ; single pulse; t <sub>p</sub> ≤ 1 ms |         | -   | 10  | A    |
| I <sub>B</sub>   | base current                      |  |         | -   | 1   | A    |
| I <sub>BM</sub>  | peak base current                 | single pulse; t <sub>p</sub> ≤ 300 μs                                |         | -   | 2   | A    |
| P <sub>tot</sub> | total power dissipation           | T <sub>amb</sub> ≤ 25 °C   | [2] [3] | -   | 2.5 | W    |
|                  |                                   |  | [2]     | -   | 550 | mW   |
|                  |                                   |  | [4]     | -   | 1   | W    |
|                  |                                   |  | [1]     | -   | 1.4 | W    |
|                  |                                   |  | [5]     | -   | 1.6 | W    |
| T <sub>j</sub>   | junction temperature              |  |         | -   | 150 | °C   |
| T <sub>amb</sub> | ambient temperature               |  |         | -65 | 150 | °C   |
| T <sub>stg</sub> | storage temperature               |  |         | -65 | 150 | °C   |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Operated under pulsed conditions; t<sub>p</sub> ≤ 10 ms; δ ≤ 0.2.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [5] Device mounted on a 7 cm<sup>2</sup> ceramic PCB, 1 cm<sup>2</sup> single-sided copper and tin-plated.



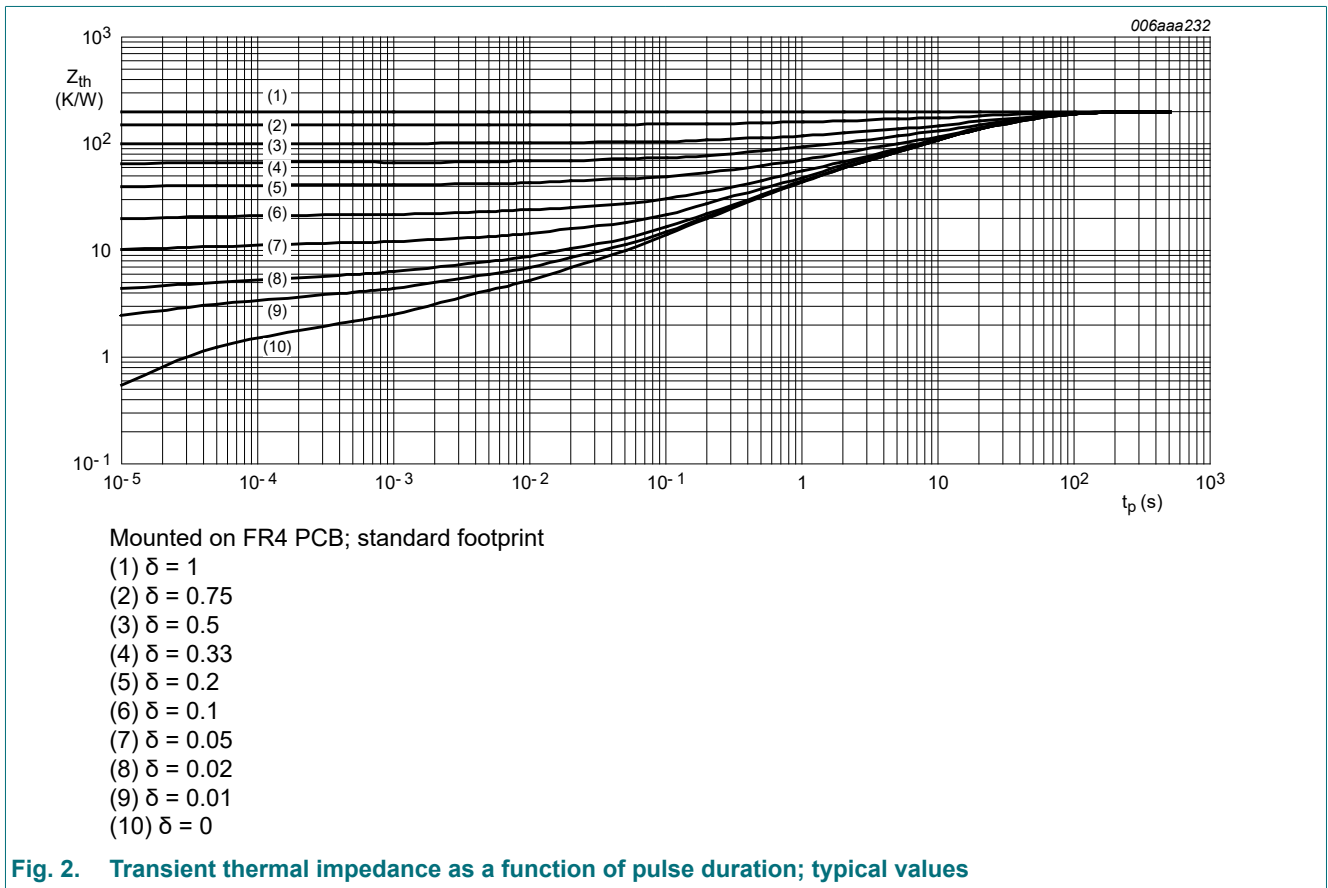
**Fig. 1. Power derating curves**

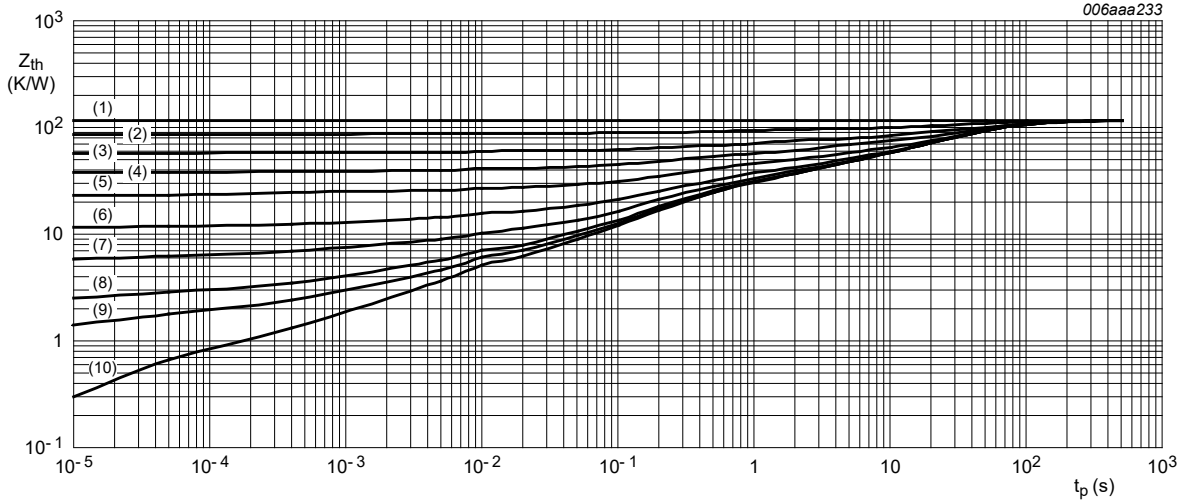
## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter  | Conditions  |         | Min | Typ | Max | Unit |
|----------------|--|-------------|---------|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1] [2] | -   | -   | 50  | K/W  |
|                |  |             | [1]     | -   | -   | 225 | K/W  |
|                |  |             | [3]     | -   | -   | 125 | K/W  |
|                |  |             | [4]     | -   | -   | 90  | K/W  |
|                |  |             | [5]     | -   | -   | 80  | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             |         | -   | -   | 16  | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Operated under pulsed conditions;  $t_p \leq 10$  ms;  $\delta \leq 0.2$ .
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [5] Device mounted on a 7 cm<sup>2</sup> ceramic PCB, 1 cm<sup>2</sup> single-sided copper and tin-plated.

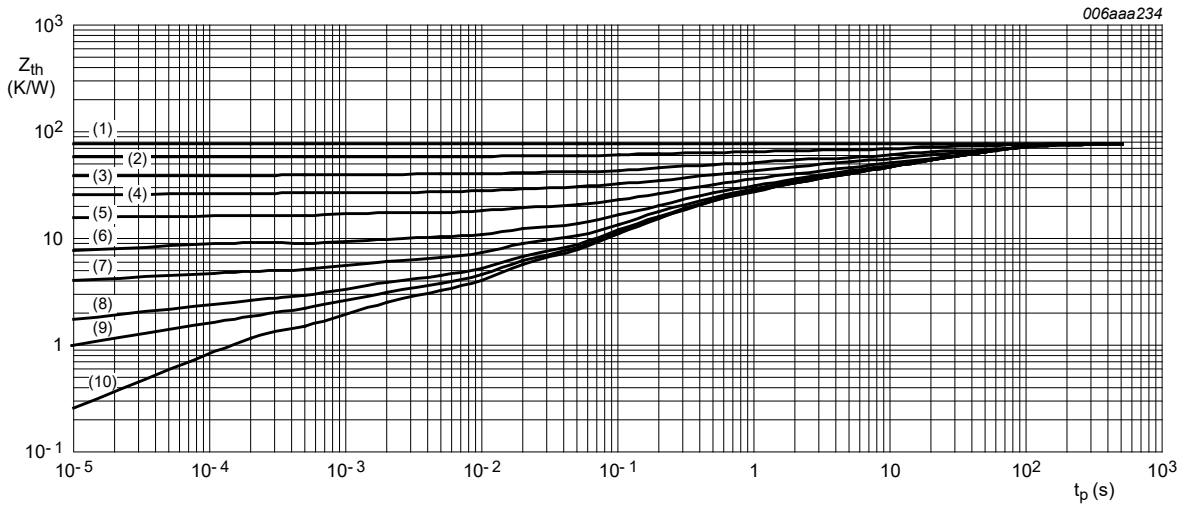




Mounted on FR4 PCB; mounting pad for collector 1 cm<sup>2</sup>

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

Fig. 3. Transient thermal impedance as a function of pulse duration; typical values



Mounted on FR4 printed-circuit board; mounting pad for collector 6 cm<sup>2</sup>

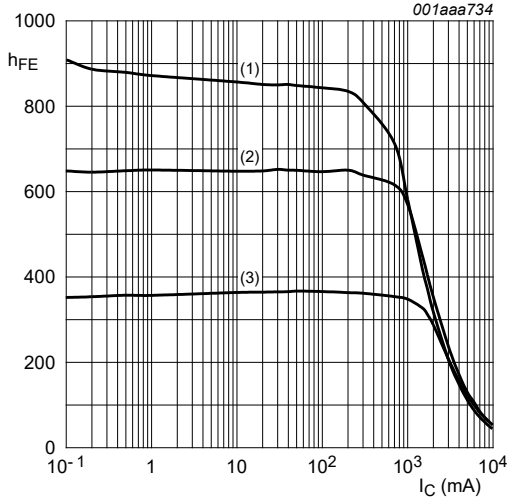
- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

Fig. 4. Transient thermal impedance as a function of pulse duration; typical values

## 10. Characteristics

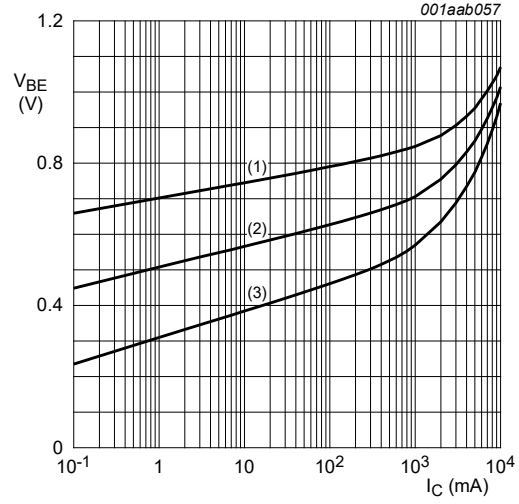
Table 7. Characteristics

| Symbol             | Parameter                               | Conditions   | Min | Typ  | Max  | Unit |
|--------------------|---|--|-----|------|------|------|
| I <sub>CBO</sub>   | collector-base cut-off current          | V <sub>CB</sub> = 80 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C   | -   | -    | 100  | nA   |
|                    |   | V <sub>CB</sub> = 80 V; I <sub>E</sub> = 0 A; T <sub>J</sub> = 150 °C  | -   | -    | 50   | μA   |
| I <sub>EBO</sub>   | emitter-base cut-off current            | V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C  | -   | -    | 100  | nA   |
| I <sub>CES</sub>   | collector-emitter cut-off current       | V <sub>CE</sub> = 80 V; V <sub>BE</sub> = 0 V; T <sub>amb</sub> = 25 °C  | -   | -    | 100  | nA   |
| h <sub>FE</sub>    | DC current gain                         | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 0.5 A; T <sub>amb</sub> = 25 °C  | 250 | 400  | -    |      |
|                    |   | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C   | 250 | 400  | -    |      |
|                    |   | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 2 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C   | 175 | 270  | -    |      |
|                    |   | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 4 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C   | 80  | 140  | -    |      |
| V <sub>CEsat</sub> | collector-emitter saturation voltage    | I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C   | -   | 25   | 40   | mV   |
|                    |   | I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C   | -   | 55   | 80   | mV   |
|                    |   | I <sub>C</sub> = 2 A; I <sub>B</sub> = 40 mA; T <sub>amb</sub> = 25 °C   | -   | 110  | 160  | mV   |
|                    |   | I <sub>C</sub> = 4 A; I <sub>B</sub> = 200 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C | -   | 170  | 230  | mV   |
|                    |   | I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C | -   | 200  | 270  | mV   |
| R <sub>CEsat</sub> | collector-emitter saturation resistance |  | -   | 40   | 54   | mΩ   |
| V <sub>BEsat</sub> | base-emitter saturation voltage         | I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C   | -   | 0.78 | 0.85 | V    |
|                    |   | I <sub>C</sub> = 1 A; I <sub>B</sub> = 50 mA; T <sub>amb</sub> = 25 °C   | -   | 0.79 | 0.9  | V    |
|                    |   | I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C | -   | 0.82 | 0.95 | V    |
|                    |   | I <sub>C</sub> = 4 A; I <sub>B</sub> = 400 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C | -   | 0.95 | 1.05 | V    |
| V <sub>BEon</sub>  | base-emitter turn-on voltage            | V <sub>CE</sub> = 2 V; I <sub>C</sub> = 2 A; T <sub>amb</sub> = 25 °C  | -   | 0.78 | 0.85 | V    |
| f <sub>T</sub>     | transition frequency                    | V <sub>CE</sub> = 10 V; I <sub>C</sub> = 100 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C                             | 120 | 150  | -    | MHz  |
| C <sub>c</sub>     | collector capacitance                   | V <sub>CB</sub> = 10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C            | -   | 35   | 50   | pF   |



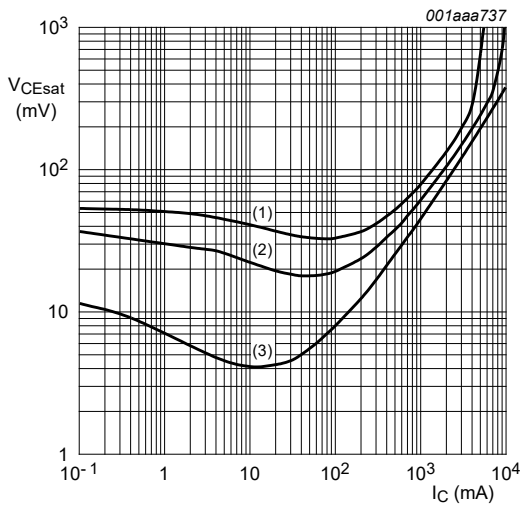
$V_{CE} = 2 V$   
 (1)  $T_{amb} = 100^\circ C$   
 (2)  $T_{amb} = 25^\circ C$   
 (3)  $T_{amb} = -55^\circ C$

Fig. 5. DC current gain as a function of collector current; typical values



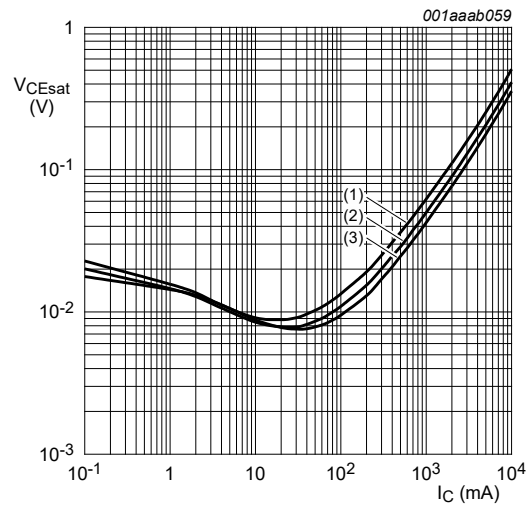
$V_{CE} = 2 V$   
 (1)  $T_{amb} = -55^\circ C$   
 (2)  $T_{amb} = 25^\circ C$   
 (3)  $T_{amb} = 100^\circ C$

Fig. 6. Base-emitter voltage as a function of collector current; typical values



(1)  $I_C/I_B = 100$   
 (2)  $I_C/I_B = 50$   
 (3)  $I_C/I_B = 10$

Fig. 7. Collector-emitter saturation voltage as a function of collector current; typical values



$I_C/I_B = 20$   
 (1)  $T_{amb} = 100^\circ C$   
 (2)  $T_{amb} = 25^\circ C$   
 (3)  $T_{amb} = -55^\circ C$

Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

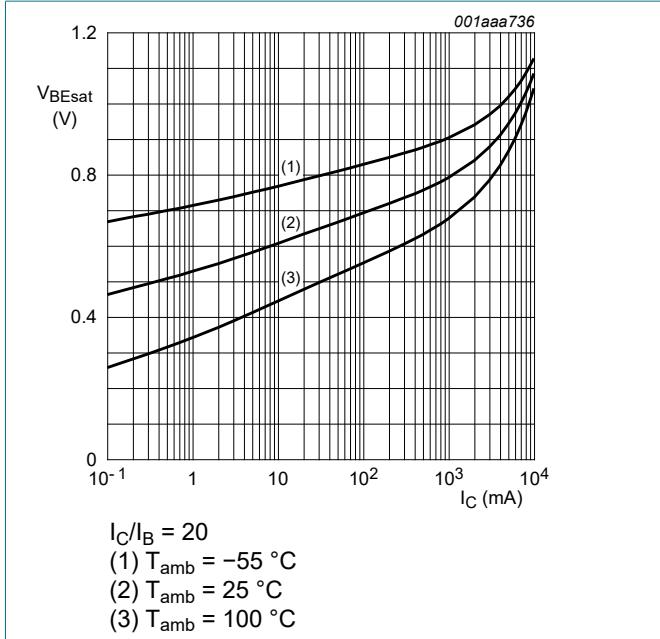


Fig. 9. Base-emitter saturation voltage as a function of collector current; typical values

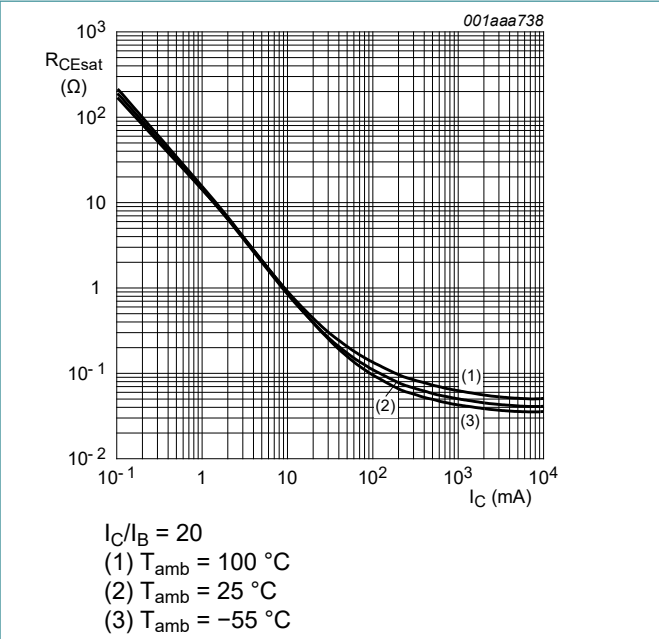


Fig. 10. Equivalent on-resistance as a function of collector current; typical values

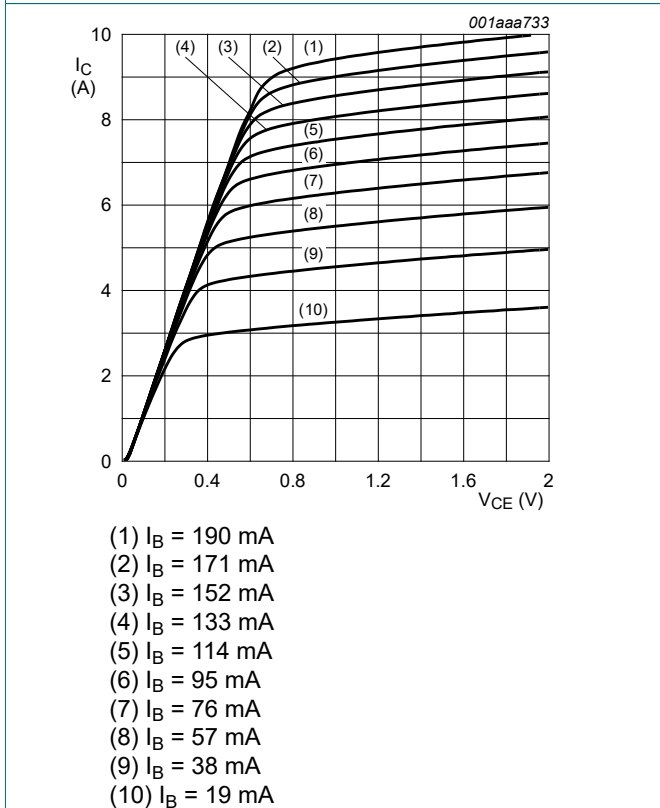


Fig. 11. Collector current as a function of collector-emitter voltage; typical values

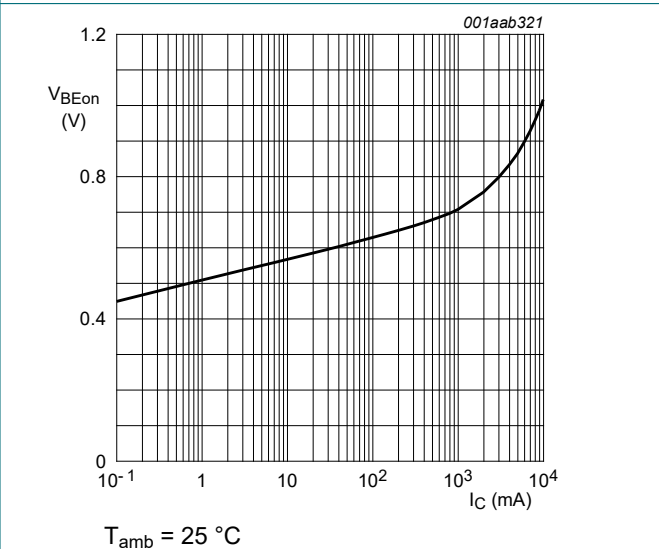


Fig. 12. Base-emitter turn-on voltage as a function of collector current; typical values



## 11. Test information

### Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

## 12. Package outline

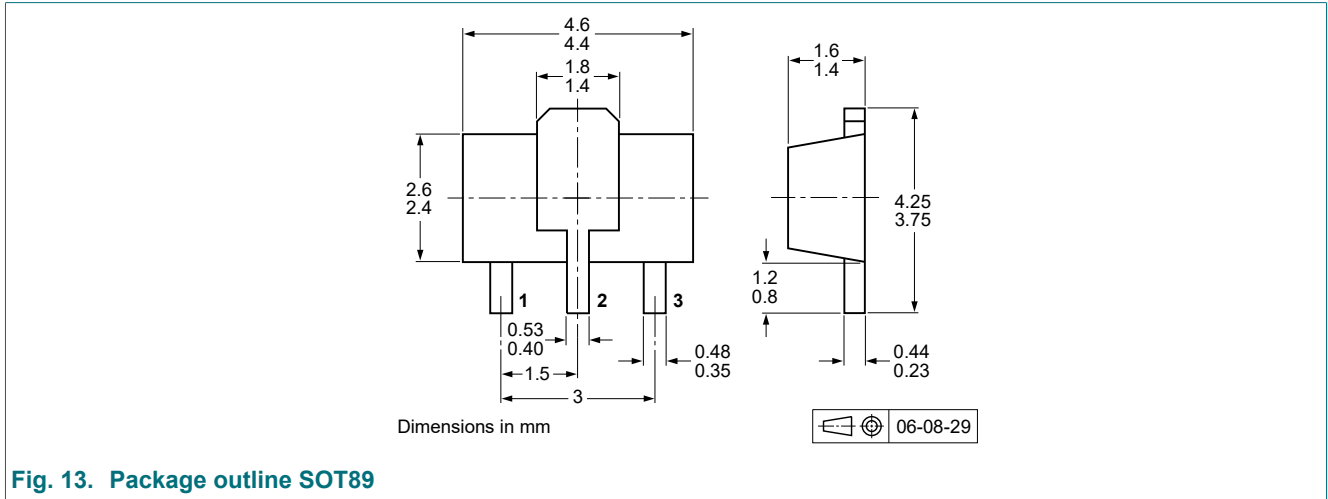


Fig. 13. Package outline SOT89

## 13. Soldering

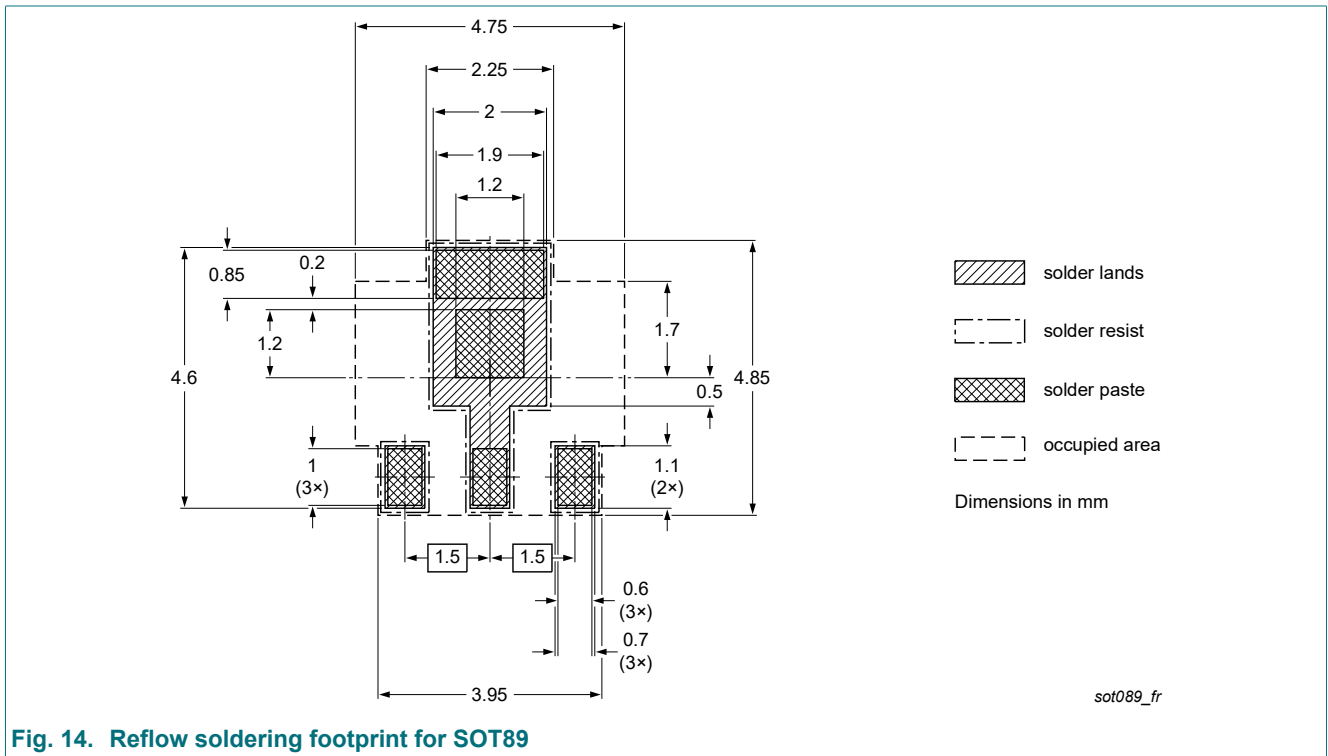


Fig. 14. Reflow soldering footprint for SOT89

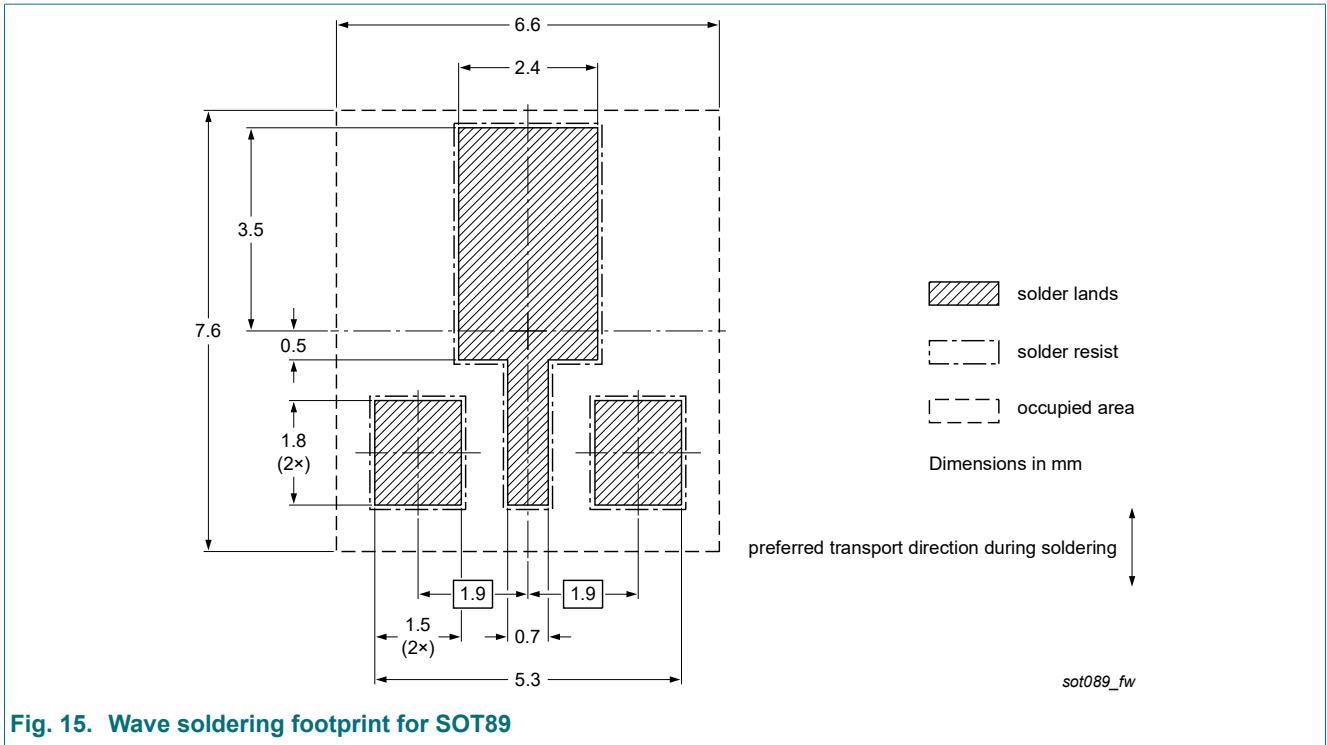


Fig. 15. Wave soldering footprint for SOT89

## 14. Revision history

Table 8. Revision history

| Data sheet ID   | Release date | Data sheet status  | Change notice | Supersedes |
|-----------------|--------------|--------------------|---------------|------------|
| PBSS4480X-Q v.1 | 20240605     | Product data sheet | -             | -          |

## 15. Legal information

### Data sheet status

| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 5 June 2024

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